# 300mA Low Quiescent Current Low-Dropout Linear Regulator

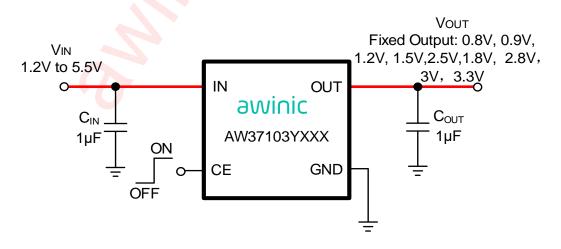
## **Features**

- Input voltage range: 1.2V to 5.5V
- Fixed outputs of 0.8V, 0.9V, 1.2V, 1.5V, 2.5V,1.8V, 2.8V, 3.0V, 3.3V
- Rated output current: 300mA
- Quiescent current: typical 2μA
- Typical 0.1μA shutdown current
- Typical 320mV dropout voltage (Iout=300mA, 1.8V output)
- Power supply rejection ratio: typical 75dB (I<sub>OUT</sub>=30mA, freq=1kHz, 1.8V output)
- Noise: typical 60µVrms (I<sub>OUT</sub>=30mA, BW=10Hz to 100kHz, 1.8V output)
- Built-in output short protection: typical 300mA when output short to ground
- DFN 1mmX1mmX0.37mm-4L package and SOT 23-5L package

# **Applications**

Battery-powered equipment Smart phone Wearables electronics

# **Typical Application Circuit**



1

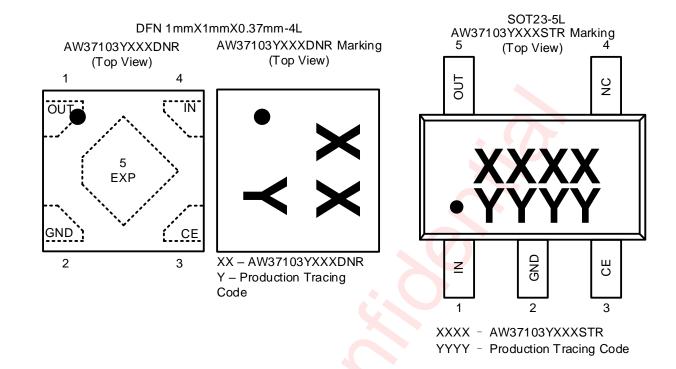
# **General Description**

AW37103YXXX is a low quiescent current low dropout voltage regulator featuring low ON resistance, high PSRR, low Noise, good load/line transient response and smooth soft-start.

AW37103YXXX integrates current limit, short circuit protection, thermal shutdown, sufficiently protecting IC from being damaged.

AW37103YXXX is designed to work with a  $1\mu$ F or more input ceramic capacitor and a  $1\mu$ F or more output ceramic capacitor. The low quiescent current make AW37103YXXX very suitable for battery application with long service life. Tiny package makes high density mounting of the IC on boards possible.

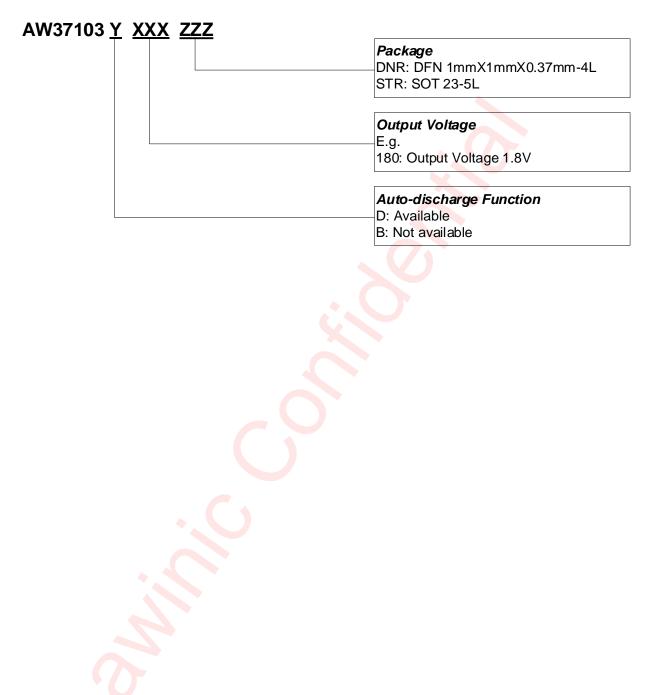
# **Pin Configuration And Top Mark**



# **Pin Definition**

Pin	Pin No.		Pin No. Pin		DESCRIPTION
DFN1*1-4L	SOT23-5L	NAME	DESCRIPTION		
1	5	OUT	Regulated output voltage pin. Put a $1\mu$ F or more ceramic capacitor at the output pin.		
2	2	GND	Ground.		
3	3	CE	Chip enable pin. Built-in 30nA pull-down current. (High Active)		
4	1	IN	Input supply pin. Put a $1\mu F$ or more bypass capacitor at the power supply.		
5		EXP	Expose pad should be tied to ground plane for better power dissipation.		

# **Name Rule**



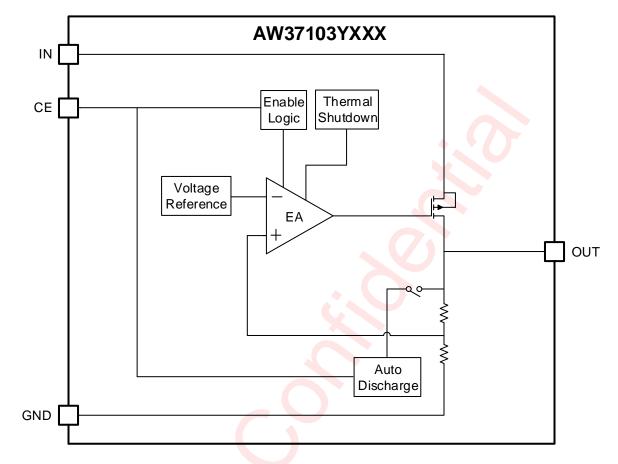
# **Device Comparison Table**

Part Number	V <sub>OUT(SET)</sub>	Rated Current	CE Active	Auto Discharge
AW37103D080DNR	0.8V	300mA	High	YES
AW37103D090DNR	0.9V	300mA	High	YES
AW37103D120DNR	1.2V	300mA	High	YES
AW37103D150DNR	1.5V	300mA	High	YES
AW37103D180DNR	1.8V	300mA	High	YES
AW37103D250DNR	2.5V	300mA	High	YES
AW37103D280DNR	2.8V	300mA	High	YES
AW37103D300DNR	3.0V	300mA	High	YES
AW37103D330DNR	3.3V	300mA	High	YES
AW37103D080STR	0.8V	300mA	High	YES
AW37103D090STR	0.9V	300mA	High	YES
AW37103D120STR	1.2V	300mA	High	YES
AW37103D150STR	1.5V	300mA	High	YES
AW37103D180STR	1.8V	300mA	High	YES
AW37103D250STR	2.5V	300mA	High	YES
AW37103D280STR	2.8V	300mA	High	YES
AW37103D300STR	3.0V	300mA	High	YES
AW37103D330STR	3.3V	300mA	High	YES

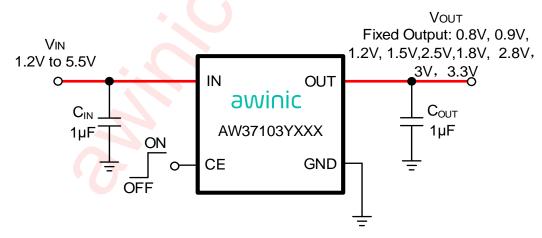


# **Functional Block Diagram**

awinic



# **Typical Application Circuits**



#### AW37103YXXX Application circuit

#### Notice for typical application circuits:

Capacitance of  $C_{\text{IN}}$  and  $C_{\text{OUT}}$  should be  $1\mu F$  or more.`

A ceramic capacitor has different temperature characteristics and bias dependencies depending on the size, manufacturer or part number of a capacitor. Careful evaluation is required. The effective capacitance of  $C_{OUT}$  should be greater than 0.7µF over the full range of operating conditions. When OUT<1.2V,choose a 2.2uF or more  $C_{OUT}$ .

# **Ordering Information**

Part Number	Temperature	Package	Marking	Moisture Sensitivity Level	Environmenta I Information	Delivery Form
AW37103D080DNR	-40°C∼85°C	DFN 1mmX1mm-4L	CR	MSL1	ROHS+HF	3000 units/ Tape and Reel
AW37103D090DNR	-40°C∼85°C	DFN 1mmX1mm-4L	SW	MSL1	ROHS+HF	3000 units/ Tape and Reel
AW37103D120DNR	-40°C∼85°C	DFN 1mmX1mm-4L	VF	MSL1	ROHS+HF	3000 units/ Tape and Reel
AW37103D150DNR	-40°C∼85°C	DFN 1mmX1mm-4L	FR	MSL1	ROHS+HF	3000 units/ Tape and Reel
AW37103D180DNR	-40°C∼85°C	DFN 1mmX1mm-4L	FV	MSL1	ROHS+HF	3000 units/ Tape and Reel
AW37103D250DNR	-40°C∼85°C	DFN 1mmX1mm-4L <	NN	MSL1	ROHS+HF	3000 units/ Tape and Reel
AW37103D280DNR	-40°C∼85°C	DFN 1mmX1mm-4L	YM	MSL1	ROHS+HF	3000 units/ Tape and Reel
AW37103D300DNR	-40°C∼85°C	DFN 1mmX1mm-4L	NS	MSL1	ROHS+HF	3000 units/ Tape and Reel
AW37103D330DNR	-40°C~85°C	DFN 1mmX1mm-4L	XN	MSL1	ROHS+HF	3000 units/ Tape and Reel
AW37103D080STR	-40°C~85°C	SOT23-5L	WDTW	MSL3	ROHS+HF	3000 units/ Tape and Reel
AW37103D090STR	-40°C~85°C	SOT23-5L	H4N5	MSL3	ROHS+HF	3000 units/ Tape and Reel
AW37103D120STR	-40°C~85°C	SOT23-5L	ZSKN	MSL3	ROHS+HF	3000 units/ Tape and Reel
AW37103D150STR	-40°C∼85°C	SOT23-5L	ZC77	MSL3	ROHS+HF	3000 units/ Tape and Reel
AW37103D180STR	-40°C∼85°C	SOT23-5L	2JTY	MSL3	ROHS+HF	3000 units/ Tape and Reel
AW37103D250STR	-40°C∼85°C	SOT23-5L	0KSU	MSL3	ROHS+HF	3000 units/ Tape and Reel

#### 上海艾为电子技术股份有眼公司 shanghai awinic technology co., ltd.

awinic

#### AW37103YXXX

Sep. 2022 V1.6

AW37103D280STR	-40°C∼85°C	SOT23-5L	QWU5	MSL3	ROHS+HF	3000 units/ Tape and Reel
AW37103D300STR	-40°C∼85°C	SOT23-5L	F3EK	MSL3	ROHS+HF	3000 units/ Tape and Reel
AW37103D330STR	-40°C∼85°C	SOT23-5L	U2M0	MSL3	ROHS+HF	3000 units/ Tape and Reel

# Absolute Maximum Ratings(NOTE1)

PARAMETERS	R	RANGE		
Input voltage range	-0.3V t	-0.3V to 6.5V		
Enable control voltage range	-0.3V t	o 6.5V		
Output voltage range	-0.3V to VIN+0	.3V, max. 6.5V		
Maximum operating junction temperature T <sub>JMAX</sub>	150	)°C		
Recommended operating junction temperature T <sub>JREC</sub>	-40°C to	o 125°C		
Operating free-air temperature range	-40°C t	o 85°C		
Storage temperature T <sub>STG</sub>	-65°C to	-65°C to 150°C		
Lead temperature (soldering 10 seconds)	260°C			
	DFN1*1-4L	232°C/W		
Junction-to-ambient thermal resistance $\theta_{JA}$ (NOTE2)	SOT23-5L	180°C/W		
ESD				
HBM (Human body model) <sup>(NOTE3)</sup>	±2	kV		
CDM(Charged device model) <sup>(NOTE4)</sup>	±1.5	ōkV		
Latch-Up				
	+IT: 2	200mA		
Latch-Up <sup>(NOTE5)</sup>	- IT: -2	- IT: -200mA		

NOTE1: Conditions out of those ranges listed in "absolute maximum ratings" may cause permanent damages to the device. In spite of the limits above, functional operation conditions of the device should within the ranges listed in "recommended operating conditions". Exposure to absolute-maximum-rated conditions for prolonged periods may affect device reliability.

NOTE2: Thermal resistance from junction to ambient follows JEDEC 2S2P standards, and is highly dependent on PCB layout.

NOTE3: All pins. Test Condition: ESDA/JEDEC JS-001-2017.

NOTE4: All pins. Test Condition: ESDA/JEDEC JS-002-2018.

NOTE5: Test Condition: JESD78E.

# **Electrical Characteristics**

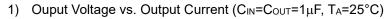
PA	ARAMETER	TEST CONDITION	MIN	ТҮР	МАХ	UNIT
VIN	Input Voltage Range		1.2		5.5	V
Vout_acc	Output Voltage Accuracy	T <sub>A</sub> =25°C, I <sub>OUT</sub> =1mA	-2		2	%
	Load Regulation	1mA≤I <sub>ou⊤</sub> ≤300mA	. (	0.5		%
	Line Regulation	Vout(set)+0.5V≤Vin ≤5.5V, Iout=1mA		1		mV
		Vout(set)=1.8V		330		
Vdropout	Dropout Voltage <sup>(1)</sup>	Vout(set)=2.8V		203		
<b>v</b> dropout	Iout=300mA	V <sub>OUT(SET)</sub> =3.0V		187		mV
		V <sub>OUT(SET)</sub> =3.3V		179		
I <sub>SD</sub>	Shutdown Current	Vce<0.4V		0.1	1	μA
lq	Quiescent Current	Ιουτ <b>=0mA</b>		2	4	μA
VCEH	CE Input Voltage "H"	-40°C ≤T₄≤85°C	1			V
V <sub>CEL</sub>	CE Input Voltage "L"	-40°C ≤T <sub>A</sub> ≤85°C			0.4	V
PSRR	Power Supply Ripple Rejection	IouT=30mA, f=1kHz VouT(SET)=1.8V		75		dB
		V <sub>OUT(SET)</sub> =0.8V		50		
	Output Voltage Noise	Vout(set)=1.8V		60		
VN	Iout=30mA	VOUT(SET)=2.8V		80		μVrms
	BW=10Hz to 100kHz	Vout(set)=3.0V		84		
		V <sub>OUT(SET)</sub> =3.3V		90		
I <sub>CL</sub>	Output Current Limit	Vout=90%*Vout(set)	300			mA
lsc	Short Current Limit	Vout<10%*Vout(set)		300		mA
VTC	Output Voltage Temperature Coefficient	-40°C ≤T <sub>A</sub> ≤85°C		±100		ppm/° C
RDISC	Auto Discharge Resistance	V <sub>IN</sub> =4.3V, V <sub>CE</sub> <0.4V		80		Ω
ICE	CE Pull Down Current			30		nA
TSDH	Thermal Shutdown Threshold	Temperature Rising		155		°C
T <sub>SDL</sub>	Thermal Shutdown Reset Threshold	Temperature Falling		130		°C

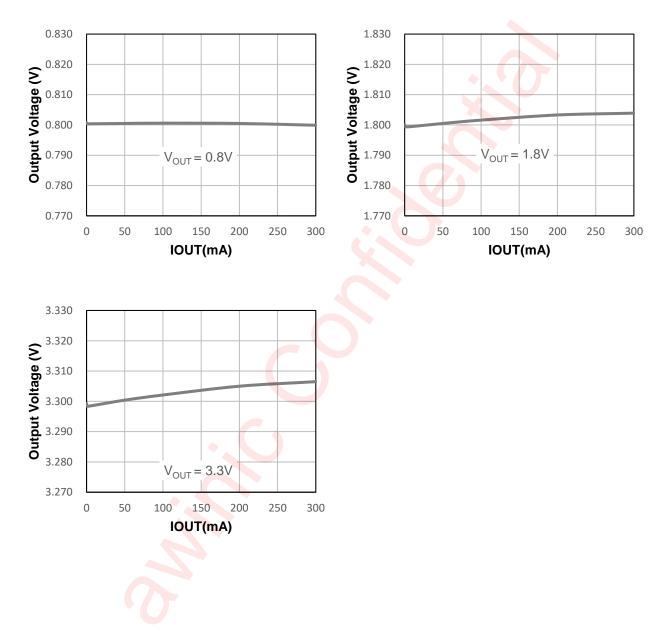
V<sub>IN</sub>=V<sub>OUT(SET)</sub>+1V, V<sub>CE</sub>>1V, I<sub>OUT</sub>=1mA, C<sub>IN</sub>=C<sub>OUT</sub>=1µF, T<sub>A</sub>=25°C (unless otherwise noted)

(1) Dropout voltage is the voltage difference between the input and the output at which the output voltage drops to 98% of its nominal value.

# **Typical Characteristics**

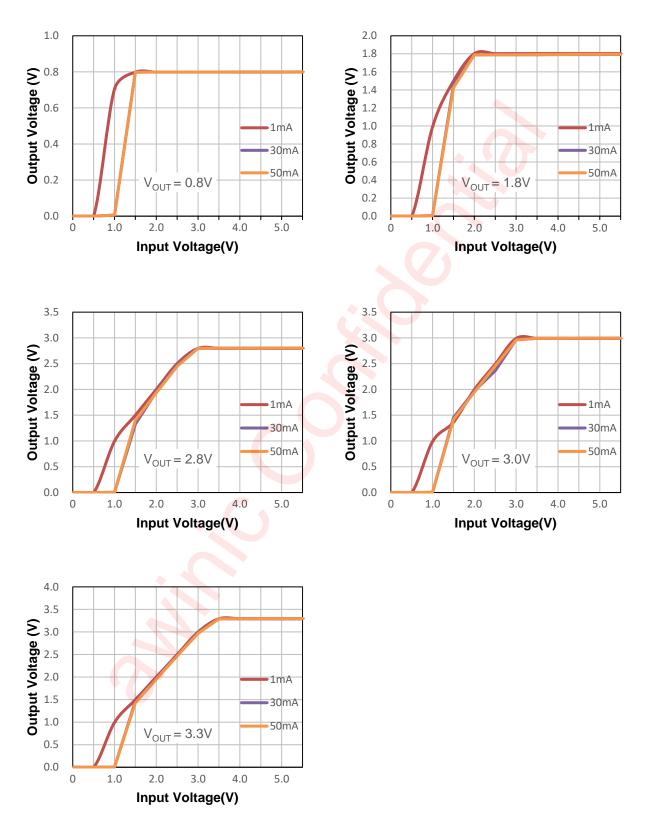
 $V_{IN}=V_{OUT(SET)}+1V$ ,  $V_{CE}>1V$ ,  $I_{OUT}=1mA$ ,  $C_{IN}=C_{OUT}=1\mu F$ ,  $T_A=25^{\circ}C$ , In Typical Application Circuit, unless otherwise noted.





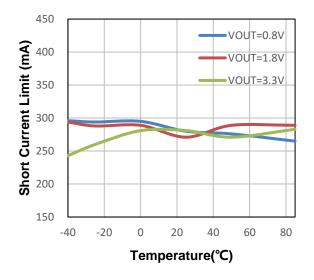
#### 2) Ouput Voltage vs. Input Voltage ( $C_{IN}=C_{OUT}=1\mu F$ , $T_A=25^{\circ}C$ )

awinic

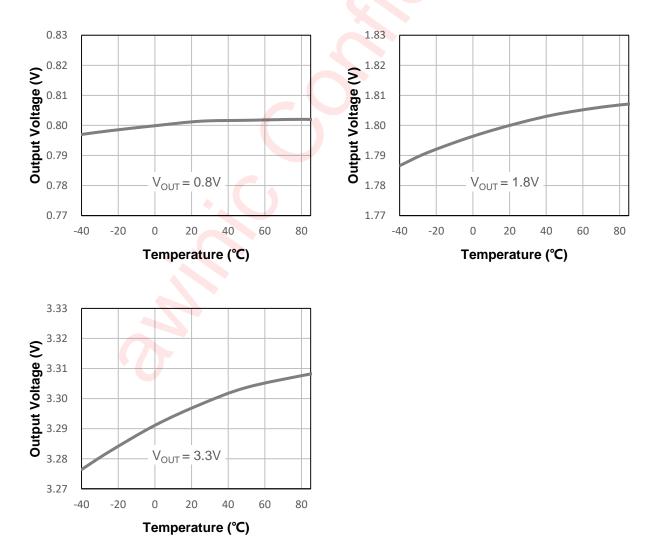






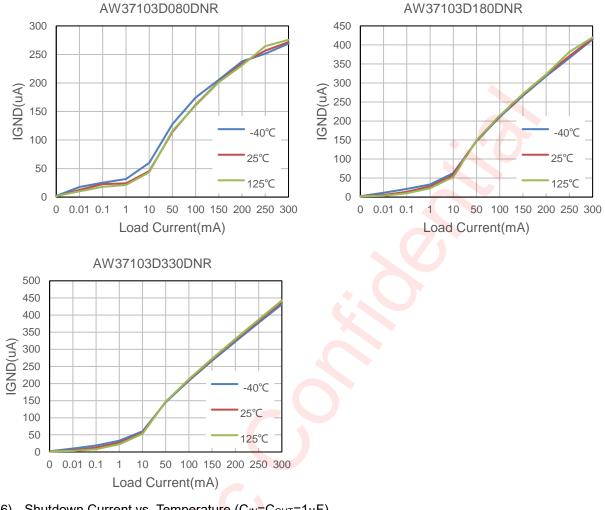


4) Ouput Voltage vs. Temperature (CIN=COUT=1µF, IOUT=1mA)

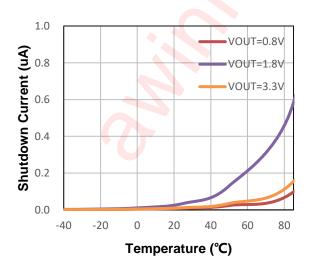


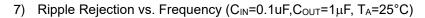
#### 5) Ground Current vs. Load Current ( $C_{IN}=C_{OUT}=1\mu F$ )

awinic

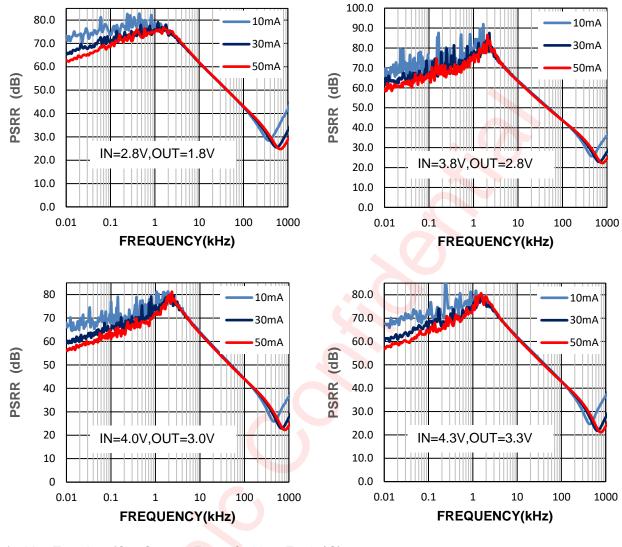


6) Shutdown Current vs. Temperature ( $C_{IN}=C_{OUT}=1\mu F$ )

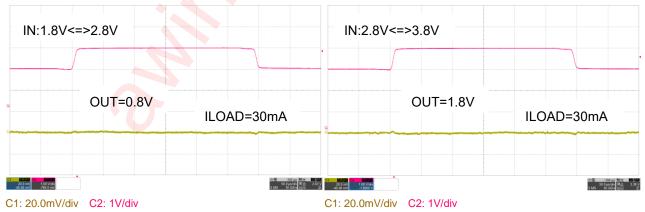




awinic



8) Line Transient ( $C_{IN}=C_{OUT}=1\mu F$ , tr = tf =10us, T<sub>A</sub>=25°C)

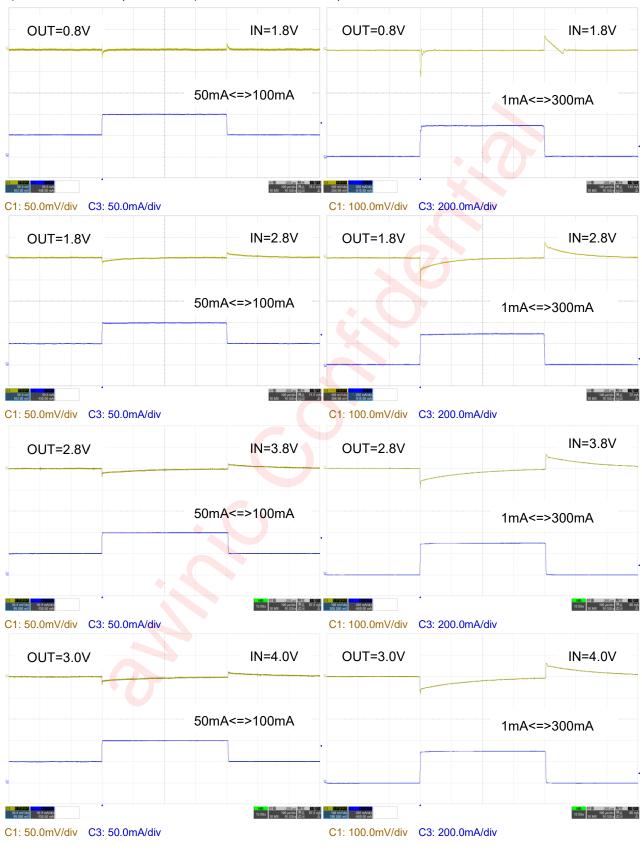




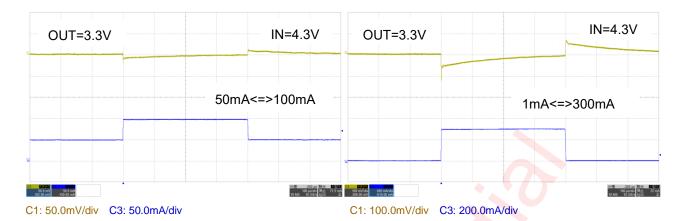




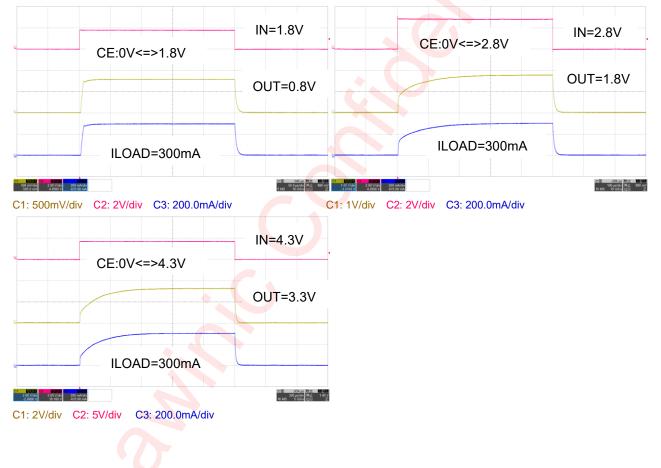
9) Load Transient ( $C_{IN}=C_{OUT}=1\mu F$ , tr=tf=1us, T<sub>A</sub>=25°C)







#### 10) Turn-on/off Waveform by CE Pin signal (C<sub>IN</sub>=C<sub>OUT</sub>=1µF, T<sub>A</sub>=25°C)



# **Detailed Functional Description**

AW37103YXXX is a low quiescent current low dropout voltage regulator. After powered on, with CE pin assertion, feedback voltage signal from the integrated resistor network and a voltage related to the voltage reference are transmit to positive input terminal and negative input terminal of an error amplifier (EA) respectively. The output signal of EA is used to control the open-state of power MOSFET. After soft-start, feedback voltage signal compares with the established reference voltage, making output voltage stable and accurate. AW37103YXXX integrates function of load transient accelerating, making LDO obtain excellent dynamic load transient response performance.

#### **Enable Operation**

AW37103YXXX uses CE pin to realize enable operation. Applying proper value of voltage to CE pin can make IC enable/disable.

If the voltage of CE pin is less than 0.4V, AW37103YXXX is guaranteed to be disabled. In this state, function modules of IC and power MOSFET are turned off. And the auto discharge function is enabled making output discharge through a on-state NMOSFET to Ground. In disable state, the ground current is reduced to a maximum of 0.5uA.

If the voltage of CE pin is more than 1V, AW37103YXXX is guaranteed to be enabled. In this state, the auto discharge function is disabled, and AW37103YXXX regulates output voltage to the designed value of voltage.

A 30nA pull down current to Ground is built-in at CE pin, making sure that the IC is disabled when CE pin floats. If Enable function is not required, CE pin should be connected directly to IN pin.

### **Output Current Limit**

AW37103YXXX integrates output current limit function, protecting IC from excessive current.

When the load is excessively heavy, AW37103YXXX limits the current flowing through the IC to a typical 500mA current. This value is specially designed, so that IC is protected properly and the output capability of 300mA is not influenced either.

Meanwhile, AW37103YXXX integrates a 300mA fold-back current limit function, lowering the system dissipation when output overload or short to Ground.

#### Thermal Shutdown

AW37103YXXX integrates thermal shutdown function, protect IC from excessively high temperature.

When the chip temperature exceeds 155°C and the output current exceeds 50mA, AW37103YXXX detects it as an over-temperature event, triggering thermal shutdown, which will turn off the main function module, including power MOSFET. This inhibits increase of chip's temperature. IC would keep the protection-state on until the chip's temperature falls below to 130°C. At this moment, the over-temperature protection-state is released, IC resumes to work again. The hysteresis avoids IC's turning off and on frequently around the the Thermal Shutdown threshold.

#### Auto Discharge

AW37103YXXX makes output voltage discharge quickly when in CE disable state or thermal shutdown state, benefit from integrating auto discharge function. Auto discharge function is implemented by integrated a NMOSFET of typical  $80\Omega$  Rdson route from Output to Ground, and the route is get through in CE disable state or thermal shutdown state. This feature prevents residual charge voltage on the output capacitor, which may impact proper power up of the system connected to the converter. It should be noted that auto discharge

function is optional according to different specs.

# **Application Information**

awinic

#### **Power Dissipation and Device Operation**

The permissible power dissipation is dependent on the ambient temperature  $T_A$  and the junction-to-ambient thermal resistance  $R_{\theta JA}$ .

The absolute maximum allowable power dissipation for the device in a given package can be calculated using Equation below, where  $T_{J\_MAX} = 150$ °C :

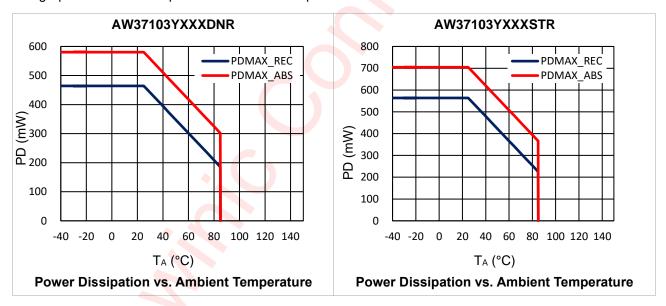
$$PD_{MAX\_ABS} = (T_{J\_MAX} - T_A) / R_{\theta JA}$$

The recommended maximum allowable power dissipation for the device in a given package can be calculated using Equation below, where  $T_{J_{REC}} = 125^{\circ}C$ :

$$PD_{MAX_{REC}} = (T_{J_{REC}} - T_A) / R_{\theta JA}$$

The actual power being dissipated in the device can be represented by Equation below:

These equations above establish the relationship between the maximum power dissipation allowed due to thermal consideration, the voltage drop across the device, and the continuous current capability of the device. The graphs of Power Dissipation vs. Ambient Temperature are showed below :



The above graphs show the maximum power dissipation of the respective package at  $T_{J_{REC}}$  = 125°C and  $T_{J_{MAX}}$  = 150°C. Operating the device in the region between PD<sub>MAX\_REC</sub> and PD<sub>MAX\_ABS</sub> might have a negative influence on its lifetime.

#### **Capacitors Selection**

#### IN pin: Input Capacitor C<sub>IN</sub>

AW37103YXXX advises to use a  $1\mu$ F or more X5R or X7R ceramic capacitor at IN pin as shown in Typical Application Circuit.

#### OUT pin: Output Capacitor Cout

AW37103YXXX advises to use a  $1\mu$ F or more X5R or X7R ceramic capacitor at OUT pin as shown in Typical Application Circuit.

# **Recommended Components List**

awinic

Component	PART No.	DESCRIPTION	MFR	TYP.	UNIT
CIN	GRM155R61A105KE15	10V, X5R, 0402	MURATA	1	μF
	GRM155R61A105KE15	10V, X5R, 0402	MURATA	1	μF
Cout	GRM153R60J225ME95	6.3V, X5R, 0402	MURATA	2.2	μF
	GRM153R60J475ME15	6.3V, X5R, 0402	MURATA	4.7	μF

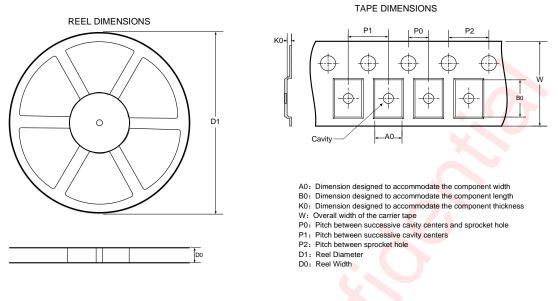
# **PCB Layout Consideration**

The performance of a power source circuit using this device is highly dependent on a peripheral circuit. To obtain the optimal performance, a peripheral component or the device mounted on PCB should not exceed its rated voltage, rated current or rated power. When designing a peripheral circuit, guidelines below for PCB layout of AW37103YXXX should be obeyed:

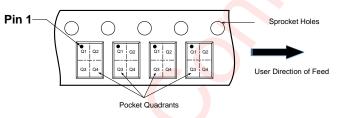
- 1. All peripheral components should be placed as close to the chip as possible. C<sub>IN</sub> and C<sub>OUT</sub> should be close to IN and OUT pins respectively. Avoid connecting device and chip pins with two different layers of copper, use the same layer of copper instead.
- 2. IN and OUT pin are the large current input and output of the chip, make IN, OUT, and meanwhile GND lines sufficient.
- 3. The connection lines between the planes of  $C_{IN}$  or  $C_{OUT}$  and respective chip pin should be as short and wide as possible, to reduce noise and EMI interference, or it may cause noise pickup or unstable operation.
- 4. The exposed plane of chip and GND pins must be connected to the large-area ground layer of PCB directly, meanwhile place sufficient vias below the exposed plane. Thus we can decrease the thermal resistor on the board to optimize heat-diffusion performance.

# **Tape And Reel Information**

DFN 1mmX1mm-4L



QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



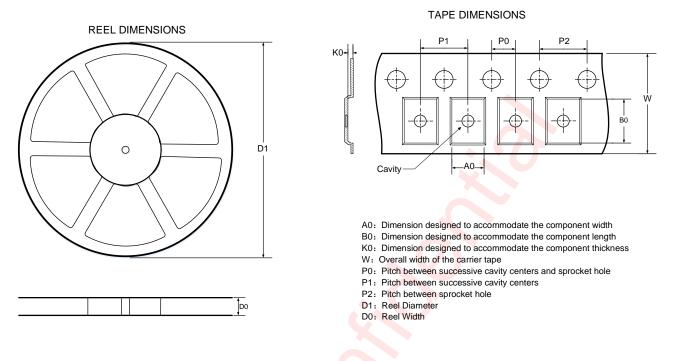
Note: The above picture is for reference only. Please refer to the value in the table below for the actual size

#### DIMENSIONS AND PIN1 ORIENTATION

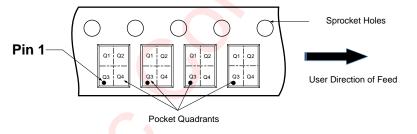
D1	D0	A0	B0	K0	P0	P1	P2	w	Disd Over desert	
(mm)	(mm)	(mm)	(mm)	(mm)	(mm)	(mm)	(mm)	(mm)	Pin1 Quadrant	
178	8.4	1.14	1.17	0.56	2	4	4	8	Q1	
All allows a										

All dimensions are nominal

SOT 23-5L



#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



Note: The above picture is for reference only. Please refer to the value in the table below for the actual size

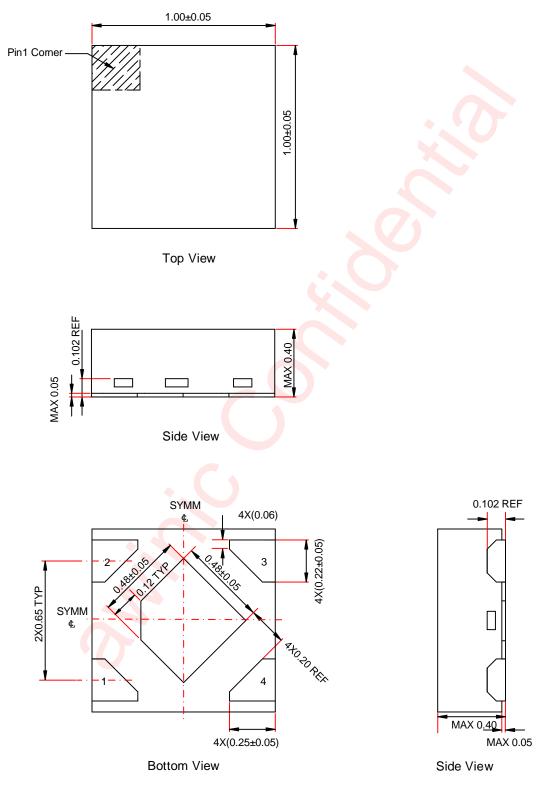
#### DIMENSIONS AND PIN1 ORIENTATION

D1	DO	A0	B0	K0	P0	P1	P2	W	Pin1 Quadrant
(mm)									
178	8.4	3.3	3.2	1.4	2	4	4	8	Q3

All dimensions are nominal

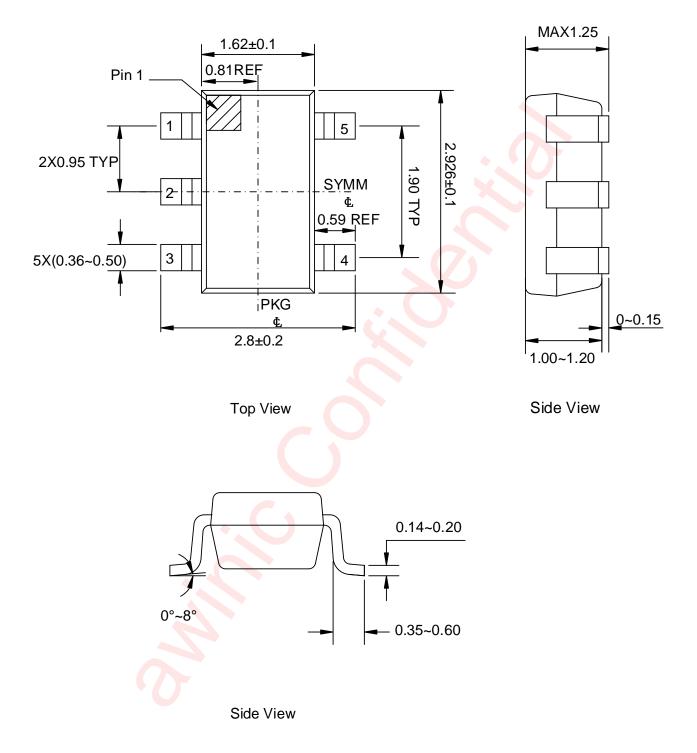
# **Package Description**

DFN 1mmX1mm-4L



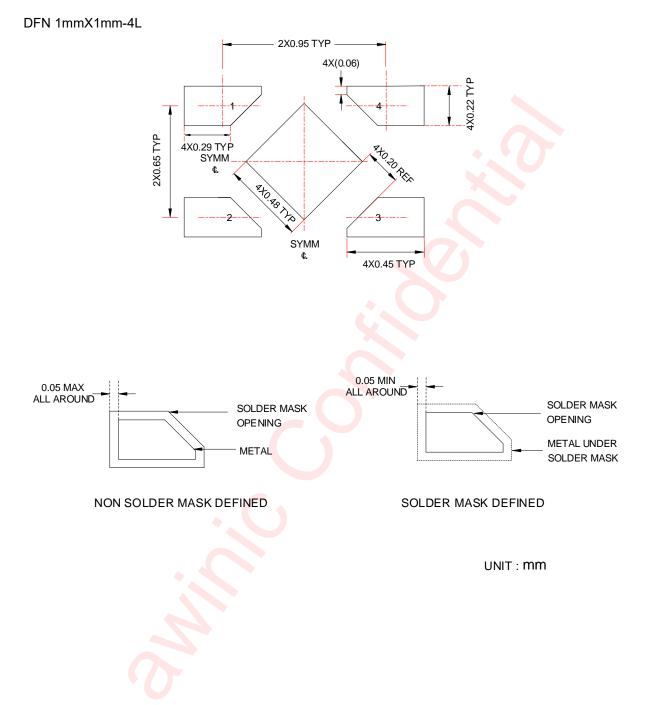


SOT 23-5L

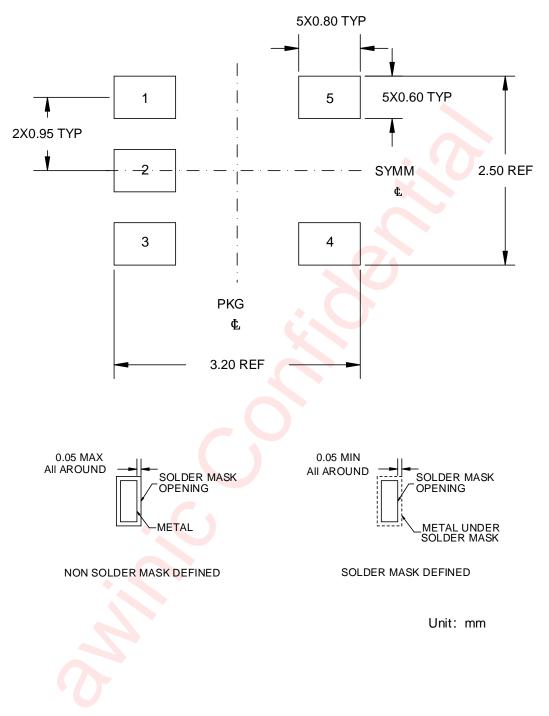


Unit: mm

# Land Pattern Data

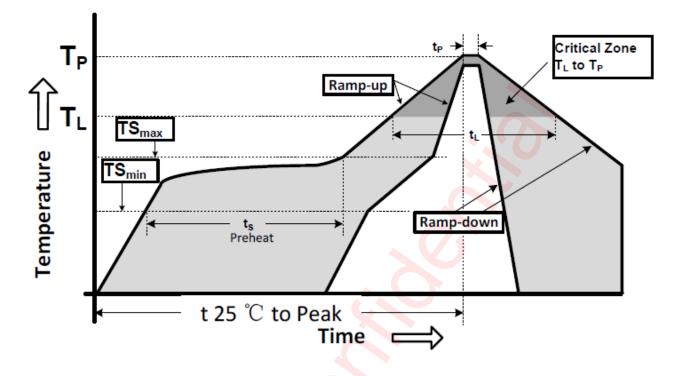


SOT 23-5L



# awinic

# Reflow



Reflow Note	Spec
Ramp-up rate (TSmax to T <sub>P</sub> )	3°C/second max.
Preheat temperature (TSmin to TSmax)	150°C to 200°C
Preheat time (t <sub>s</sub> )	60 - 180 seconds
Time above T <sub>L</sub> , 217°C $(t_L)$	60 - 150 seconds
Peak temperature (TP)	260°C
Time within 5°C of peak temperature(t <sub>P</sub> )	20 - 40 seconds
Ramp-down rate	6°C/second max.
Time 25°C to peak temperature	8 minutes max.



# **Revision History**

Version	Date	Change Record
V1.0	Mar. 2021	Officially released
V1.1	Jul. 2021	Add curve: Ground Current vs. Load Current
V1.2	Oct. 2021	Add 2.8V and 3.0V curve
V1.3	Jan. 2022	Add 1.2V edition
V1.4	Jun. 2022	Add max value of Quiescent Current; Add graphs of Power Dissipation vs. Ambient Temperature; Add reflow curve; Update Tape And Reel Information
V1.5	Aug. 2022	Update SOT 23-5L package description
V1.6	Sep. 2022	Add 1.5V and 2.5V edition

www.awinic.com

# awinic 上海交び shanghai

# **Disclaimer**

All trademarks are the property of their respective owners. Information in this document is believed to be accurate and reliable. However, Shanghai AWINIC Technology Co., Ltd (AWINIC Technology) does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information.

AWINIC Technology reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. Customers shall obtain the latest relevant information before placing orders and shall verify that such information is current and complete. This document supersedes and replaces all information supplied prior to the publication hereof.

AWINIC Technology products are not designed, authorized or warranted to be suitable for use in medical, military, aircraft, space or life support equipment, nor in applications where failure or malfunction of an AWINIC Technology product can reasonably be expected to result in personal injury, death or severe property or environmental damage. AWINIC Technology accepts no liability for inclusion and/or use of AWINIC Technology products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Applications that are described herein for any of these products are for illustrative purposes only. AWINIC Technology makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

All products are sold subject to the general terms and conditions of commercial sale supplied at the time of order acknowledgement.

Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

Reproduction of AWINIC information in AWINIC data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. AWINIC is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of AWINIC components or services with statements different from or beyond the parameters stated by AWINIC for that component or service voids all express and any implied warranties for the associated AWINIC component or service and is an unfair and deceptive business practice. AWINIC is not responsible or liable for any such statements.

单击下面可查看定价,库存,交付和生命周期等信息

>>AWINIC(艾为)